

Power Driver SMT Chip Mounter For 0402 - 17mm Components / Producing Lens / LED Tube

Basic Information

Place of Origin: CHINABrand Name: ETON

Certification: CCC,SIRA,CEModel Number: HT-E8D-1200

• Minimum Order Quantity: 1PCS

Packaging Details: WE USE VACUUM WOODEN BOC

PACKAGE

Delivery Time: 5-8 work days
Payment Terms: L/C, T/T
Supply Ability: 50PCS/Month



Product Specification

Model: HT-E8D-1200Warranty: 12 Months

Name: SMD Chip Mounter,SMT Pick And Place

Machine, SMT Chip Mounter

Application: SMD Production Line,SMT Mounting Shooter

Machine,SMT Production Line,for SMT

Machine

Power Supply: 380V 50HZ

• Condition: 100% Original, Brand-new

• Product Name: Place Machine\ LED Mounter\LED Assembly

Machine, Automatic SMT Mounting Shooter, SMT Shooter Machine

• Weight: 2500KG

• Mounting Speed: 90000 CPH

Usage: Circuit Board Assembly,SMT Mounting

Machine,SMD

• Dimension: 3150*2250*1650mm



Product Description

SMT machine can mount components for 0402-17mm, producing lens,led tube,led bulb,flexible strip,power driver etc.

Product Details

Model Number:E8D-1200 Dimension:3150*2250*1650mm

Heads:24pcs Weight:2500kg

Mounting Speed:90000CPH Power:380AC 50HZ

Feeder:48pcs double module Core Components:Motor

Brand:ETON

Visual camera:4set of imported camera Place of Origin:Guangdong, China Warranty:1 Year

Machinery Test Report:Provided Delivery:Within 30 Days



SMT production line

SMT production line main equipment: Printing Machine, SMT machine (upper surface electronic component), reflow soldering, plug-in, wave oven, test packaging. The widespread application of SMT has promoted the miniaturization and multi-function of electronic products, and provided conditions for the production of mass production and low defect rate products. SMT is the surface assembly technology, which is a new generation of electronic assembly technology developed from hybrid integrated circuit technology.



Prospect

With the development of IC packaging in the direction of high integration, high performance, multi-lead and narrow spacing, it promotes the application of SMT technology in high-end electronic products, there are many technical difficulties. Since 1998, BGA devices have been widely used, especially in the communication industry. The proportion of BGA devices has been increasing rapidly. At the same time, SMT technology is driven by high-end products such as communication, entered a rapid, good development period.

About PCBA



1.PCBA process: PCBA = Printed Circuit Board Assembly, that is, empty PCB through SMT, then DIP plug-in through the entire process, referred to as PCBA process.

Industry status: due to the production of printed circuit board in the latter half of the manufacturing of electronic equipment, it is regarded as the downstream industry of the electronics industry. Almost all electronic devices require printed circuit board support, making printed circuit board the world's largest electronic component product by market share. Japan, China, Taiwan, Western Europe and the US are the main printed circuit board manufacturing bases.

2.In recent years, the output value of HDI board, Packaging Board and Flexible Board has increased along with the decline of single/double panel and Multilayer Board, it shows that the application in computer motherboard, communication backboard, automobile board and other fields is growing slowly, the application of high-end mobile phones, laptops and other "Thin short" electronic products, HDI board, Packaging Board and Flexible Board will also maintain rapid growth.



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